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Product Summary

B520C/B530C/B540C

V _{RRM} (V)	I _O (A)	V _{F max} (V)	I _{R max} (mA)
20/30/40	5.0	0.55	0.5

B550C/B560C

V _{RRM} (V)	I _O (A)	V _{F max} (V)	I _{R max} (mA)
50/60	5.0	0.70	0.5

Description and Applications

This Schottky Barrier Rectifier is designed to meet the general requirements of commercial applications. It is ideally suited for use as a:

- Polarity Protection Diode
- Re-Circulating Diode
- Switching Diode

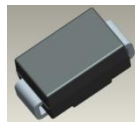
Features and Benefits

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- For Use in Low-Voltage, High-Frequency Inverters, Free Wheeling, and Polarity Protection Application
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Notes 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

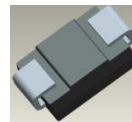
Mechanical Data

- Case: SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 [Ⓔ]
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.21 grams (Approximate)

SMC



Top View



Bottom View

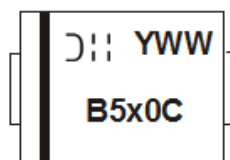
Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
B5xxC-13-F	Standard	SMC	3,000/Tape & Reel
B540CQ-13-F	Automotive	SMC	3,000/Tape & Reel

* xx = Device type, e.g. B520C-13-F (SMC package).

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



B5x0C = Product Type Marking Code, ex: B540C (SMC package)

YWW = Manufacturers' Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 4 for 2014)

WW = Week Code (01 to 53)

x = 2,3,4,5 or 6 - i.e., x = 4 for B540C

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	B520C	B530C	B540C	B550C	B560C	Unit
Peak Repetitive Reverse Voltage	V_{RRM}						
Working Peak Reverse Voltage	V_{RWM}	20	30	40	50	60	V
DC Blocking Voltage	V_R						
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	35	42	V
Average Rectified Output Current	I_O	5.0					A
Non-Repetitive Peak Forward Surge Current, 8.3 ms Single Half-Sine-Wave Superimposed on Rated Load	I_{FSM}	100					A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Terminal	$R_{\theta JT}$	10	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	50	$^\circ\text{C}/\text{W}$
Operating Temperature Range	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V_F	—	0.475 0.575	0.55 0.70	V	$I_F = 5.0\text{A}$, $T_A = +25^\circ\text{C}$
Leakage Current (Note 6)	I_R	—	—	0.5 20	mA	@ Rated V_R , $T_A = +25^\circ\text{C}$ @ Rated V_R , $T_A = +100^\circ\text{C}$
Total Capacitance	C_T	—	—	300	pF	$V_R = 4\text{V}$, $f = 1\text{MHz}$

Notes: 5. Thermal Resistance: Junction to ambient, unit mounted on PC board with 8.0 mm² (0.033 mm thick) copper pads as heat sink.
6. Short duration pulse test used to minimize self-heating effect.

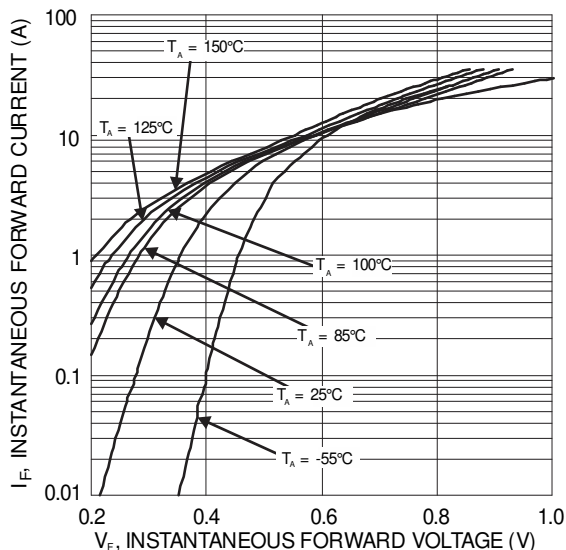


Figure 1 Typical Forward Characteristics (B520C - B540C)

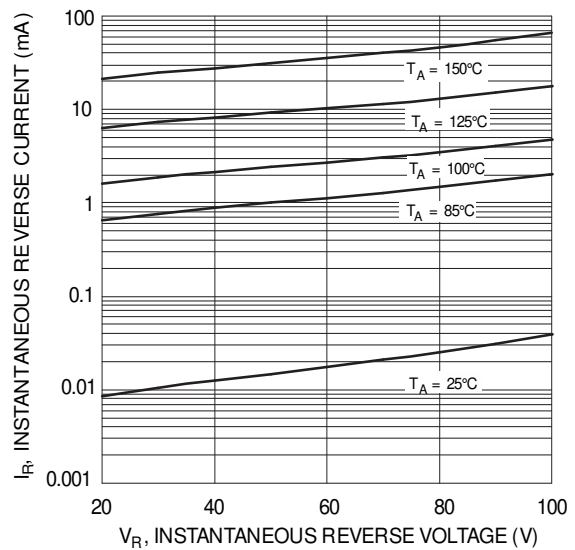
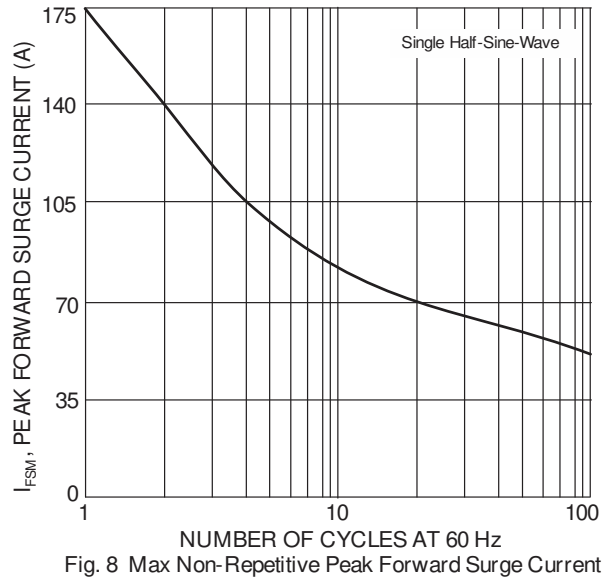
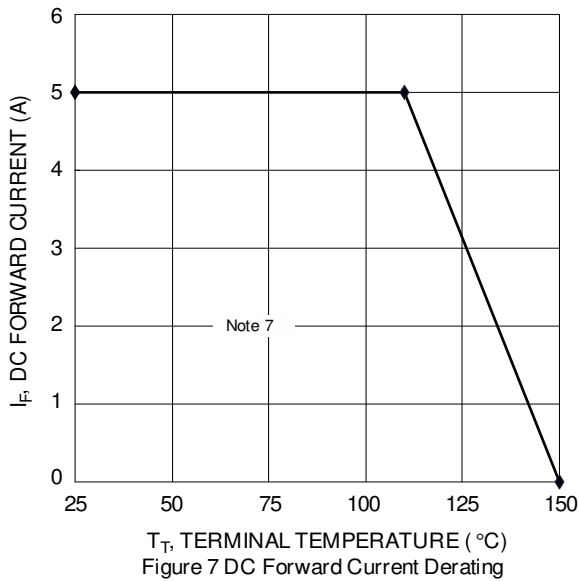
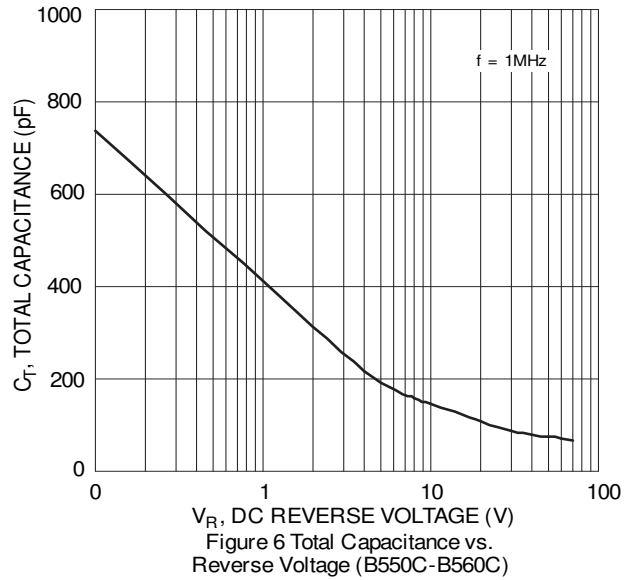
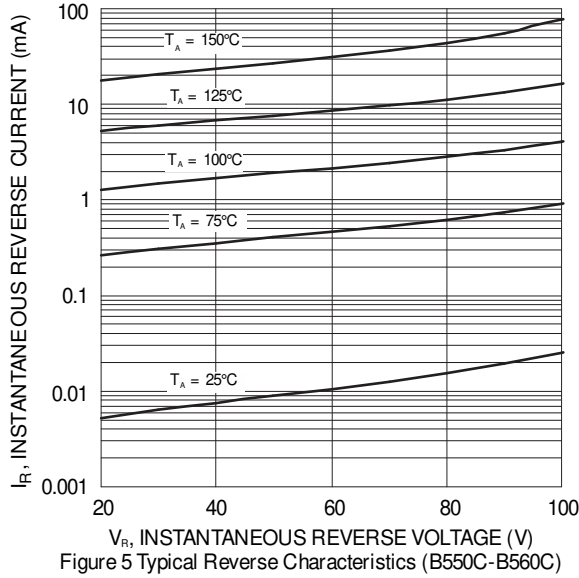
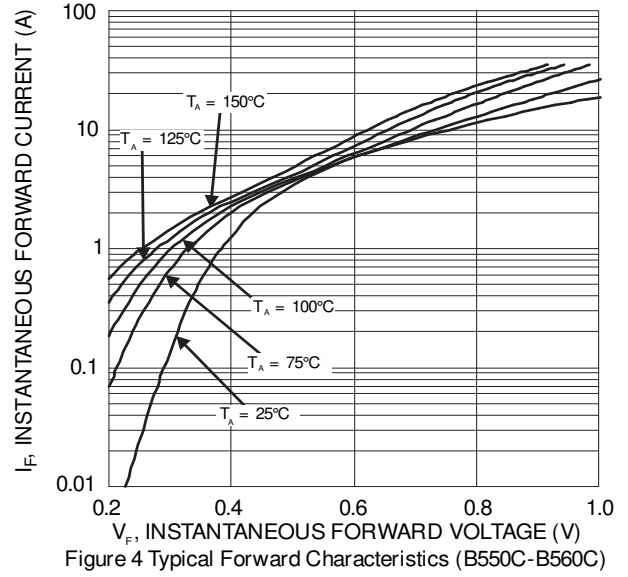
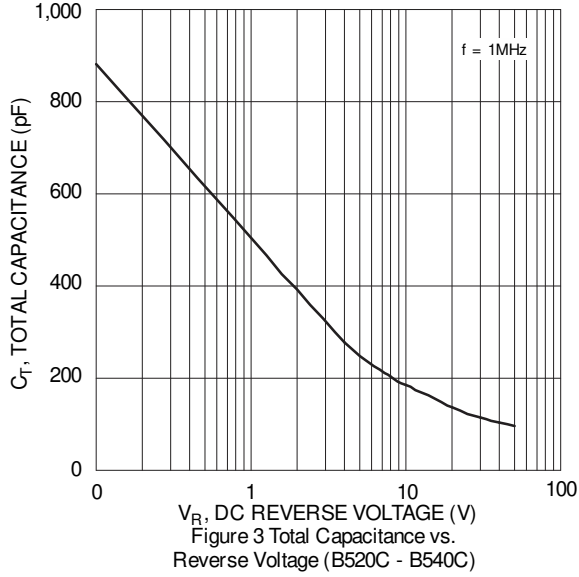


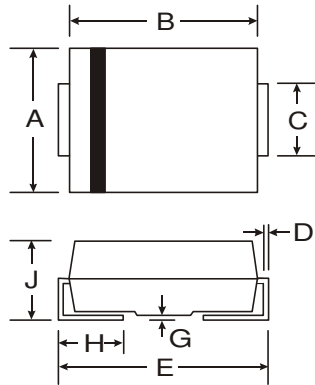
Figure 2 Typical Reverse Characteristics (B520C - B540C)



Note: 7. Device mounted on FR-4 substrate, 1" x 1", 2oz, single-sided, PC boards with 0.56" x 0.73" copper pad.

Package Outline Dimensions

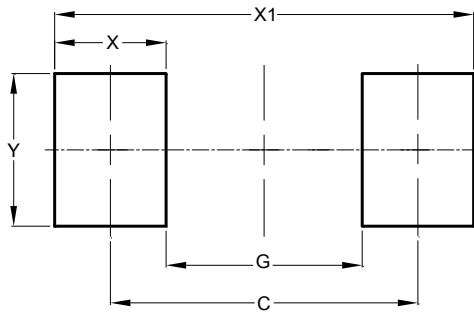
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SMC		
Dim	Min	Max
A	5.59	6.22
B	6.60	7.11
C	2.75	3.18
D	0.15	0.31
E	7.75	8.13
G	0.10	0.20
H	0.76	1.52
J	2.00	2.50
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	6.90
G	4.40
X	2.50
X1	9.40
Y	3.30

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